Overview

HP 255 G7 Notebook PC



- 1. Webcam LED
- 2. Webcam
- 3. Internal microphone
- 4. Touchpad
- 5. Touchpad button
- 6. Audio combo jack

Left

- 7. USB 3.1 Gen 1 port
- 8. USB 3.1 Gen 1 port
- 9. HDMI port (Cable not included)
- 10. RJ-45/Ethernet port
- 11. AC Smart Pin adapter plug
- 12. Power button

Overview



- 1. Security lock slot (Lock sold separately)
- 2. Optical drive (optional)
- 3. USB 2.0 port

Right

- 4. SD Card slot
- 5. Hard drive indicator LED
- 6. Power indicator LED

QuickSpecs

Overview

AT A GLANCE

- Preinstalled with Windows 10 versions or FreeDOS
- Choice of AMD Ryzen™ processors
- 15.6" (39.6 cm) diagonal FHD/HD Anti-Glare Display
- Choice of Integrated AMD Radeon™ Vega 8 Mobile Graphics, AMD Radeon™ R4 Graphics, AMD Radeon™ R3 Graphics and AMD Radeon™ Graphics.
- Dark Ash Silver or Asteroid Silver color with texture pattern (Color options available in select countries)
- Up to 1TB Hard Drive or 256 GB M.2 PCIe Value Solid State Drive
- Weight starting at 1.78Kgs (3.91 lbs)
- Security features including FW TPM 2.0 and security lock slot (Lock not included)
- Keyboard Full size textured island-style keyboard with numeric pad
- Touchpad with gestures support
- HP webcam with single digital microphone and HD (supporting WDR- Wide Dynamic Range) or VGA camera
- Two USB 3.1 (Gen 1) ports and One USB 2.0 port
- Wireless LAN (WLAN) up to 802.11ac to keep you connected
- Battery Life up to 10 hours and 30 minutes

NOTE: See important legal disclosures for all listed specs in their respective features sections.



PRODUCT NAME

HP 255 G7 Notebook PC

OPERATING SYSTEM

Preinstalled OS Windows 10 Pro 64¹

Windows 10 Home 64¹

Windows 10 Home Single Language 64¹ Windows 10 Pro 64 (National Academic only)²

FreeDOS

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com/.

2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

PROCESSOR

AMD Ryzen™ 5 2500U APU with Radeon™ Vega 8 Graphics (2 GHz base frequency, up to 3.6 GHz burst frequency,

6 MB cache, 4 cores)3,4,5,26

AMD Ryzen™ 3 2200U APU with Radeon™ Vega 3 Graphics (2.5 GHz base frequency, up to 3.4 GHz burst frequency,

5 MB cache, 2 cores)3,4,5,26

AMD A9-9425 APU with Radeon™ R5 Graphics (3.1 GHz base frequency, up to 3.7 GHz burst frequency,

1 MB cache. 2 cores)3,4,5,26

AMD A6-9225 APU with Radeon™ R4 Graphics (2.6 GHz base frequency, up to 3 GHz burst frequency,

1 MB cache, 2 cores)^{3,4,5}

AMD A4-9125 APU with Radeon™ R3 Graphics (2.3 GHz base frequency, up to 2.6 GHz burst frequency,

1 MB cache. 2 cores)3,4,5

AMD Ryzen™ 5 3500U APU with Radeon™ Vega 8 Mobile Graphics (2.1 GHz base frequency, up to 3.7 GHz burst frequency,

4 MB cache, 4 cores)^{3,4,5}

AMD Ryzen™ 3 3250U APU with Radeon™ Graphics (2.6 GHz base frequency, up to 3.5 GHz burst frequency,

1 MB cache, 2 cores)^{3,4,5}

AMD Athlon™ Gold 3150U APU with Radeon™ Graphics (2.4 GHz base frequency, up to 3.3 GHz burst frequency,

1 MB cache, 2 cores)^{3,4,5}

AMD Athlon™ Silver 3050U APU with Radeon™ Graphics (2.3 GHz base frequency, up to 3.2 GHz burst frequency,

1 MB cache, 2 cores)3,4,5

Processor Family

AMD Ryzen™ 5 Mobile Processors⁵

AMD Ryzen™ 3 Mobile Processors^{5,26}

AMD Athlon™ Mobile Processors5

7th Generation AMD A9 APU processor (A9-9425) 5,26

7th Generation AMD A6 APU processor (A6-9225) 5



7th Generation AMD A4 APU processor (A4-9125)5

- 3. Multi core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering, branding and/or naming is not a measurement of clock speed.
- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode. 5. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.
- 26. Not available on Aug 1st 2020

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

AMD Radeon Vega 8 Mobile Graphics AMD Radeon Vega 3 Mobile Graphics²⁶ AMD Radeon™ R5 Graphics²⁶ AMD Radeon™ R4 Graphics AMD Radeon™ R3 Graphics

Supports

Support HD decode, DX12, HDMI 1.4b6

6. HDMI cable sold separately.26. Not available on Aug 1st 2020

DISPLAY

Internal

Non-Touch

39.6 cm (15.6") diagonal HD SVA eDP anti-glare WLED-backlit slim, 220 cd/m 2 , 67% sRGB (1366 x 768) $^{7.8,27}$ 39.6 cm (15.6") diagonal FHD SVA eDP anti-glare WLED-backlit slim, 220 cd/m 2 , 67% sRGB (1920 x 1080) $^{7.8,27}$

HDMI

Port supports resolutions up to 1920 x 1200 external resolution @60 Hz

- 7. HD content required to view HD images.
- 8. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
- 27. Sold separately or as an optional feature.

STORAGE AND DRIVES



Primary Storage

1 TB 5400 rpm SATA⁹ 500 GB 7200 rpm SATA⁹ 500 GB 5400 rpm SATA⁹

Primary M.2 Storage

128 GB SATA-3 TLC Solid State Drive⁹
256 GB SATA-3 TLC Solid State Drive⁹
256 GB PCIe Gen3x4 NVMe Value Solid State Drive⁹
512 GB PCIe Gen3x4 NVMe Value Solid State Drive⁹

9. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

MEMORY

Maximum Memory

16 GB DDR4-2400 SDRAM¹⁰ 8 GB DDR4-1866 SDRAM¹⁰

Memory

16 GB DDR4-2400 SDRAM (2 x 8 GB) ¹⁰
8 GB DDR4-2400 SDRAM (1 x 8 GB)
8 GB DDR4-2400 SDRAM (2 x 4 GB) ¹⁰
4 GB DDR4-2400 SDRAM (1 x 4 GB)
8 GB DDR4-1866 SDRAM (1 x 8 GB)
4 GB DDR4-1866 SDRAM (1 x 4 GB)
8 GB DDR4-1866 SDRAM (2 X 4 GB) ¹⁰

Memory Slots

2 SODIMM (AMD Ryzen™ Mobile Processors)
DDR4 PC4 SODIMMS, system runs at 2400
Supports Dual Channel Memory¹¹
Both slots are customer non-accessible / non-upgradeable

1 SODIMM (7th Generation AMD APU processor and Athlon™ Mobile Processors) DDR4 PC4 SODIMMS, system runs at 1866 All slots are customer non-accessible / non-upgradeable

10. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

11. Dual channel memory support only for AMD Ryzen™ APU processors.

NETWORKING/COMMUNICATIONS

WLAN

Realtek 802.11ac (1x1) and Bluetooth® 4.2 Combo¹²
Realtek 802.11ac (2x2) Wi-Fi® and Bluetooth® 5.0 Combo (MU-MIMO supported)¹²

Miracast

Compatible with Miracast-certified devices¹³



Ethernet

Integrated 10/100/1000 GbE NIC

- 12. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited.
- 13. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

AUDIO/MULTIMEDIA

Audio

2 Integrated stereo speakers

Camera

HP TrueVision HD Camera^{7,14}

Webcam

VGA webcam¹⁴

Optical Drive

Optional DVD-Writer15,16

- 7. HD content required to view HD images.
- 14. Sold separately or as an optional feature.
- 15. Unit shipped with either "DVD+/-RW SuperMulti DL" or "DVD Writer Drive." Units undergoing repairs may be returned with a "DVD+/-RW SuperMulti DL."
- 16. HD-DVD disks cannot be played on this drive. No support for DVDRAM. Actual speeds may vary. Don't copy copyright protected materials. Double Layer discs can store more data than single layer discs; discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

Keyboard - Full size textured island-style keyboard with numeric pad

Pointing Device

Touchpad with multi-touch gesture support

Function Keys

- F1 Open " How to get help in Windows 10" webpage
- F2 Brightness Down
- F3 Brightness Up
- F4 Display Switching
- F5 Blank
- F6 Mute
- F7 Volume Down
- F8 -Volume Up
- F9 Previous
- F10 Play/Pause
- F11 Next
- F12 Airplane mode



SOFTWARE AND SECURITY

Preinstalled Software

HP JumpStarts
HP Documentation
HP Setup Integrated OOBE

SSRM is provided via SSRU/SSRD format, also can be download from Cloud. But it's not default preinstalled in image.

HP Audio Switch

HP Support Assistant¹⁷

McAfee LiveSafe™

Security Management

TPM 2.0¹⁸

Security lock slot (Lock sold separately)

17. HP Support Assistant requires Windows and Internet access.

18. Firmware TPM is version 2.0. Hardware TPM is v1.2, which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT). TPM is version 2.0. Hardware TPM is v1.2, which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT).

POWER

Power Supply

65 W EM Smart AC adapter¹⁹ 45 W Smart AC adapter¹⁹

Primary Battery

3-cell, 41 Wh Li-ion Battery²⁰

Power Cord

1M (3.28 feet) length power cord¹⁹

Battery Life

Up to 10 hours and 30 minutes hrs21

Battery Weight

0.18 kg 0.39 lb

- 19. Availability may vary by country.
- 20. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 21. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See http://www.bapco.com for additional details.



WEIGHTS & DIMENSIONS

Product Weight

Starting at 3.91 lbs²² Starting at 1.78 kgs²²

Product Dimensions (w x d x h)

14.8 x 9.68 x 0.89 in 37.6 x 24.6 x 2.25 cm

22. Weight will vary by configuration.

PORTS/SLOTS

Ports

2 USB 3.1 Gen 1 1 USB 2.0 1 HDMI v1.4b⁶ 1 RJ-45 1 AC power 1 Headphone/microphone combo jack

Expansion Slots

1 multi-format digital media reader Supports SD, SDHC, SDXC

6. HDMI cable sold separately.

SERVICE AND SUPPORT

HP Services offers 1-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. Onsite service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc. ²³

23. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.





SYSTEM UNIT

Stand-Alone Power Requirements (AC

Power)

Nominal Operating Voltage 19.5 V Average Operating Power Win 10 Integrated graphics 6.87W

Max Operating Power Discrete < 65W

UMA < 45W

Temperature

Operating 32° to 95° F (0° to 35° C) (not writing optical)

41° to 95° F (5° to 35° C) (writing optical)

Non-operating -4° to 140° F (-20° to 60° C)

Relative Humidity

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%

Shock

Operating 40 G, 2 ms duration, half-sine Non-operating 240 G, 2 ms duration, half-sine

Random Vibration

Operating 1.043 grms
Non-operating 3.5 grms

Planned Industry Standard

Certifications

UL Yes
CSA No
FCC Compliance Yes
ENERGY STAR® Yes²⁴

EPEAT® 2019 Yes, Silver in U.S.²⁵

ICES Yes Australia / Yes **NZ A-Tick Compliance** Yes CCC Yes Japan VCCI Compliance Yes KC Yes **BSMI** Yes **CE Marking Compliance** Yes **BNCI or BELUS** Yes CIT Yes GOST Yes Saudi Arabian Compliance (ICCP) Yes SABS Yes



UKRSERTCOMPUTER

Yes

24. Configurations of the HP 255 G7 that are ENERGY STAR® certified are identified as HP 255 G7 ENERGY STAR on HP websites and on http://www.energystar.gov.

25. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit http://www.epeat.net for more information.

DISPLAYS

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

15.6" diagonal HD WLED AntiGlare (1366x768) slim-flat (3.2mm) SVA. eDP

Outline Dimensions 360 x 224.3 x 3.2 (max) $(W \times H \times D)$

Active Area Weight

Thickness

Interface

344.2 x 193.5 420 max. **Diagonal Size** 15.6 (inch) 3.2mm max eDP 1.2 (1 lane) **Surface Treatment** Anti-glare (AG)

N0

Touch Enabled

Contrast Ratio 300:1 (typ) **Refresh Rate** 60Hz **Brightness** 220 nit typ

Pixel Resolution

1366 x 768 (HD) **Format** RGB Configuration

Backlight LED

Color Gamut Coverage 45%

Color Depth 6 bits (Hi FRC) **Viewing Angle** SVA 40/40/15/30

15.6" diagonal FHD WLED Outline Dimensions AntiGlare (1920x1080) slim-flat (3.2mm) SVA, eDP

360.0 x 224.3mm max

 $(W \times H \times D)$

Active Area 344.16 x 193.59 Weight 370g max. **Diagonal Size** 15.6 (inch) **Thickness** 3.2mm max Interface eDP 1.2 **Surface Treatment** Anti-glare (AG)

Touch Enabled N0

Contrast Ratio 300:1 (typ) **Refresh Rate** 60Hz **Brightness** 220 nit typ

Pixel Resolution **Format** 1920 x 1080 (FHD)



Configuration	RGB
---------------	-----

Backlight LED **Color Gamut Coverage** 45%

Color Depth 6 bits + FRC **Viewing Angle** SVA 45/45/25/35

STORAGE AND DRIVES

500 GB 5400 rpm SATA **Dard Drive**

Drive Weight 92q(0.20lb) **Rotation speed** 5400 rpm **Cache Buffer** Up to 128MB

Height 7.0 +/- 0.2 mm (0.28 +/-.008 in)

69.85 +/- 0.25 mm (2.750 +/- 0.010 in) Width

Interface **ATA-8, SATA 3.0**

Transfer Rate 600 MB/s

Seek Time Single Track: 1.5 ms

> Average: 13 ms Maximum: 32ms

Logical Blocks 976,773,168 **Operating Temperature** 0° to 60°C **Security Features ATA Security**

Features S.M.A.R.T., NCQ, Ultra DMA

500 GB 7200 rpm SATA **Hard Drive**

Drive Weight <95q (0.209lb) **Rotation speed** 7200 rpm **Cache Buffer** Up to 128 MB

Height 7.0 +/- 0.2 mm (0.28 +/-.008 in)

69.85 +/- 0.25 mm (2.750 +/- 0.010 in) Width

Interface **ATA-8, SATA 3.0**

Transfer Rate 600 MB/s

Seek Time Single Track: 1.5 ms

> Average: 13 ms Maximum: 32 ms

Logical Blocks 976,773,168

Operating Temperature 0° to 60°C **Security Features ATA Security**

Features S.M.A.R.T., NCQ, Ultra DMA

1 TB 5400 rpm SATA

Drive Weight 90q(0.198lb) **Hard Drive Rotation speed** 5400 rpm



Cache Buffer Up to 128MB

Height 7.0 +/- 0.2 mm (0.28 +/-.008 in)

Width 69.85 +/- 0.25 mm (2.750 +/- 0.010 in)

Interface ATA-8, SATA 3.0

Transfer Rate 600 MB/s

Seek Time Single Track: 1.5 ms

Average: 13 ms Maximum: 32 ms

Logical Blocks 976,773,168 **Operating Temperature** 0° to 60°C **Security Features** ATA Security

Features S.M.A.R.T., NCQ, Ultra DMA

128 GB 2280 M2 SATA-3 TLC Solid State Drive
 Drive Weight
 0.02 lb (10 g)

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate 550MB/s **Logical Blocks** 250,069,680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Security Features ATA Security

Features DIPM; TRIM; DEVSLP

256 GB 2280 M2 SATA-3 TLC Solid State Drive
 Drive Weight
 0.02 lb (10 g)

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate 550MB/s **Logical Blocks** 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Security Features ATA Security

Features DIPM; TRIM; DEVSLP

256 GB 2280 M2 PCIe NVMe Value Solid State Drive Form Factor M.2 2280
Capacity 256 GB
NAND Type TLC

Height 0.09 in (2.3 mm)

Width 0.87 in (22 mm)

Weight $0.01 \text{ lb } (6 \text{ q}) \sim 0.02 \text{ lb } (10 \text{ q})$

InterfacePCIe NVMe Gen3x2Maximum SequentialUp To 1500 MB/s

Read

Maximum Sequential

Write

Up To 900 MB/s

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM; L1.2

NETWORKING/COMMUNICATIONS

WLAN

Realtek RTL8821CE 802.11ac 1x1 Wi-Fi® and Bluetooth® 4.2 Combo Adapter (MU-MIMO supported)¹ Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac

InteroperabilityWi-Fi CERTIFIED™Frequency Band•802.11b/g/n

2.402 – 2.482 GHz

•802.11a/n

4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz

Data Rates •802.11b: 1, 2, 5.5, 11 Mbps

•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

•802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security³ •IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only

•AES-CCMP: 128 bit in hardware

•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

•WPA2 certification
•IEEE 802.11i

•Cisco Certified Extensions, all versions through CCX4 and CCX Lite

WAPI



Network Architecture Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power² •802.11b: +14dBm minimum

•802.11g: +12dBm minimum •802.11a: +12dBm minimum

•802.11n HT20(2.4GHz): +12dBm minimum •802.11n HT40(2.4GHz): +12dBm minimum •802.11n HT20(5GHz): +10dBm minimum •802.11n HT40(5GHz): +10dBm minimum •802.11ac VHT80(5GHz): +10dBm minimum

Power Consumption •Transmit: 2.0 W (max)

•Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)
Idle mode: 50 mW (WLAN unassociated)
Connect Standby: 10 mW (WLAN+BT)

Radio disabled: 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴ 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

 Weight
 Type 2230: 2.8g

 Operating Voltage
 3.3v +/- 9%

Temperature Operating 14° to 158° F (–10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF

LED White - Radio ON



HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2 Compliant **Frequency Band** 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH) Channels BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps signaling data rate up to 2.17 Mbps

BLE: 1 Mbps signaling data rate up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

3. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Realtek RTL8822CE 802.11ac 2x2 Wi-Fi® and Bluetooth® 5.01

Wireless LAN Standards

IEEE 802.11a IEEE 802.11b

IEEE 802.11q

IEEE 802.11n

IEEE 802.11ac

IEEE 802.11d

IEEE 802.11e IEEE 802.11h

IEEE 802.11i

IEEE 802.11k

IEEE 802.11r

IEEE 802.11v

Interoperability Wi-Fi CERTIFIED™

Frequency Band •802.11b/q/n

2.402 - 2.482 GHz

•802.11a/n/ac

4.9 – 4.95 GHz (Japan)

5.15 - 5.25 GHz

5.25 - 5.35 GHz

5.47 - 5.725 GHz

5.825 - 5.850 GHz

Data Rates •802.11b: 1, 2, 5.5, 11 Mbps



•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

•802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz & 160MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security³ •IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only

•AES-CCMP: 128 bit in hardware

•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

•WPA2 certification •IEEE 802.11i

WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

• 802.11b: +18.5dBm minimum • 802.11g: +17.5dBm minimum

• 802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum

• 802.11ac VHT160(5GHz): +11.5dBm minimum

Power Consumption • Transmit mode 2.0 W

•Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
Idle mode 50 mW (WLAN unassociated)
Connected Standby/Modern Standby: 10mW

Radio disabled 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴ 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to



support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard with CNVi Interface

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

Type 1216: 1.67 x 12.0 x 16.0 mm

Weight Type 2230: 2.8 g

Type 126: 1.3 g

Operating Voltage 3.3v +/- 9%

Temperature Operating: 14° to 158° F (-10° to 70° C)

Non-operating: -40° to 176° F (-40° to 80° C)

Humidity Operating: 10% to 90% (non-condensing)

Non-operating: 5% to 95% (non-condensing)

Altitude Operating: 0 to 10,000 ft (3,048 m)

Non-operating: 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF

LED OFF - Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2/5.0 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH)

Channels BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps Signaling Data Rate 2.17 Mbps

BLE: 1 Mbps Signaling Data Rate 0.2 Mbps

1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 4 dBm for BR and EDR.

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Electrical Interface USB 2.0 compliant

Bluetooth Software Microsoft W

Supported

Microsoft Windows Bluetooth Software

Link Topology

Power Management Microsoft

Power Management Microsoft Windows ACPI, and USB Bus Support **Certifications** FCC (47 CFR) Part 15C. Section 15.247 & 15.249

Power Management ETS 300 328, ETS 300 826
Certifications Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles
Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full

LE Secure Connection- Basic/Full LE Privacy 1.2 —Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

- 1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited.
- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Power

HP 65 W Smart AC adapter **Dimensions** (H x W x D) 108 x 47 x 37.4 mm

Weight 250 g

Not including power cord. Power cord varies by country

Input 100 to 240 VAC

Input Efficiency 88.0 % at 115 VAC and 89.0 % at 230VAC

Input frequency range 50~ 60 Hz

Input AC current Max. 1.7 A at 90 VAC

Output Output power 65 W

DC output 19.5 V

Hold-up time 5 ms at 115 VAC input

Output current limit The power supply shall limit the

maximum steady state output current to

an average current of 11 Amperes.

Connector 4.5 mm Barrel Type



Environmental Design Operating 32° to 95° F (0° to 35° C)

temperature

Non-operating (storage) temperature

-4° to 185° F (-20° to 85° C)

Altitude The power supply can be operated at

5,000 m above sea level

Humidity The power supply shall withstand

without degradation with 95% relative humidity, non-condensing, both operating and non-operating

EMI and Safety Certifications *CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1,

SELV;

Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC

Class B,

CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

Weight 200 g

Not including power cord. Power cord varies by country

Input 100 to 240 VAC

Input Efficiency 87.8 % at 115 VAC and 88.5 % at 230VAC

Input frequency range 50~ 60 Hz

Input AC current Max. 1.4 A at 90 VAC

Output Output power 45 W

DC output 19.5 V

Hold-up time 5ms at 115 VAC input

Output current limit The power supply shall limit the maximum

steady state output current to an average

current of 8 Amperes.

Connector 4.5 mm Barrel Type

Environmental Design Operating 32° to 95° F (0° to 35° C) temperature

Non-operating (storage)

-4° to 185° F (-20° to 85° C)

Altitude The power supply can be operated at 5,000

m above sea level

Humidity The power supply shall withstand without

degradation with 95% relative humidity, non-condensing, both operating and non-

operating

EMI and Safety Certifications *CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1,

SELV;

Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC

Class B,

CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

HP	65	W	Sm	ıar	t
AC	ada	ap	ter	(E	M)

Dimensions (H x W x D) 102 x 55 x 30 mm

Weight 270 c

Not including power cord. Power cord varies by country

Input 100 to 240 VAC

Input Efficiency 88.0 % at 115 VAC and 89.0 % at 230VAC

Input frequency range 50~ 60 Hz

Input AC current Max. 1.7 A at 90 VAC

Output Output power 65 W

DC output 19.5 V

Hold-up time 5ms at 115 VAC input

Output current limit The power supply shall limit the maximum

steady state output current to an average

current of 11 Amperes.

Connector 4.5 mm Barrel Type

Environmental DesignOperating
temperature
32° to 95° F (0° to 35° C)

Non-operating (storage)

temperature [°]

-4° to 185° F (-20° to 85° C)

Altitude The power supply can be operated at 5,000

m above sea level

Humidity The power supply shall withstand without

degradation with 95% relative humidity, non-condensing, both operating and non-

operating

EMI and Safety Certifications *CE Mark - full compliance with LVD and EMC directives

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SELV;

Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC

Class B.

CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

HP 3-cell Li-Ion (41 WHr)

Dimensions (H x W x L) 6.0 x 186.85 x 90.2 mm (0.236 x 7.35 x 3.55 inch)

Weight 0.18 kg (0.39 lb)

Cells/Type 3cell Lithium-Ion Polymer cell / 515974

 Voltage
 11.4V/11.34V

 Amp-hour capacity
 3.6Ah/3.62Ah

Watt-hour capacity 41 Wh

Operating (Charging) 32° to 113° F (0° to 45° C) **Operating (Discharging)** 14° to 122° F (-10° to 60° C)

Optional Travel Battery

Available

No

Dimensions (H x W x L) 6.0 x 186.85 x 90.2 mm (0.236 x 7.35 x 3.55 inch)

HP 3-cell Li-Ion

(41 WHr)

Weight 0.19 kg (0.41 lb)

Cells/Type 3cell Lithium-Ion Prismatic cell / 496080

Voltage 11.55V

Amp-hour capacity 3.615Ah/3.63Ah

Watt-hour capacity 41Wh

Operating (Charging) 32° to 113° F (0° to 45° C)
Operating (Discharging) 14° to 122° F (-10° to 60° C)

Optional Travel Battery No

Available



Country of Origin

China



QuickSpecs

Category	Description	Part Number
Cases	HP Essential Top Load Case	H2W17AA#xxx
	HP Essential Backpack (up to 15.6")	H1D24AA
	HP Essential Messenger Case (up to 17.3")	H1D25AA
Docking	HP 3005PR USB3 Port Replicator	Y4H06AA
	HP USB Travel Dock	TOK30AA
	HP Monitor Stand	M9X76AA
Input/Output	HP Slim USB Keyboard and Mouse	T6T83AA
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP 3-Button USB Laser Mouse	H4B81AA
	HP USB Travel Mouse	G1K28AA
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP Ultra Mobile Wireless Mouse	H6F25AA#xxx
	HP HDMI to DVI Adapter	F5A28AA
	HP Stereo USB Headset	T1A67AA
	HP Stereo 3.5mm Headset	T1A66AA
Power	HP 45W Smart AC Adapter 4.5mm	H6Y88AA#XXX
	HP 65W Smart AC Adapter	H6Y89AA#xxx
	HP 65W Slim AC Adapter	H6Y82AA#xxx
Storage	HP External USB Optical Drive	F2B56AA
Memory	HP 4GB 2666Mhz DDR4	4VN05AA
	HP 8GB 2666Mhz DDR4	4VN06AA
Displays	HP S140u 14-inch Portable Display	G8R65AA
	HP ProDisplay P223 21-5 inch Monitor	X7R61AA
	HP ProDisplay P232 23-inch Monitor	K7X31AA
	HP ProDisplay P240va 23.8-inch Monitor	N3H14AA
	HP EliteDisplay S14 14-inch USB-C Portable Monitor	3HX46AA



QuickSpecs

Summary of Changes

Date of change:	Version History:	Description of change:
	From v1 to v2	

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